

## P-Channel Enhancement Mode Power MOSFET

### Description

The PE7340G uses advanced trench technology to provide excellent  $R_{DS(ON)}$  and low gate charge. It can be used in a wide variety of applications.

### General Features

- $V_{DS} = -30V$ ,  $I_D = -50A$

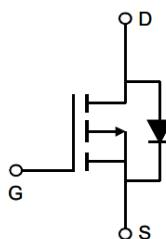
$R_{DS(ON)} < 11m\Omega$  @  $V_{GS}=-10V$

$R_{DS(ON)} < 17m\Omega$  @  $V_{GS}=-4.5V$

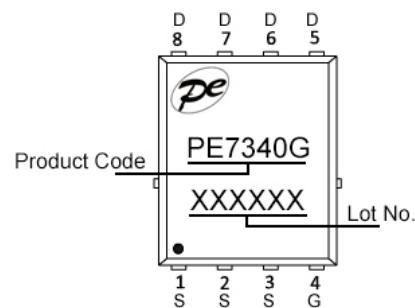
- High Power and current handing capability
- Lead free product is acquired
- Surface Mount Package

### Application

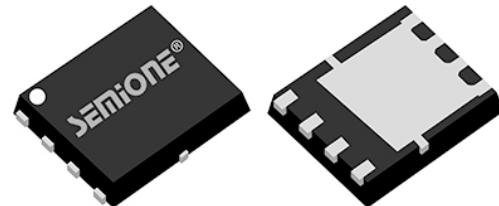
- PWM applications
- Load switch
- Power management



Schematic diagram



Marking and pin assignment



DFN5x6-8L

### Absolute Maximum Ratings (TC=25°C unless otherwise noted)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DS}$	-30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current-Continuous	$I_D$	-50	A
Drain Current-Continuous(TC=100°C)	$I_D$	-30	A
Pulsed Drain Current (Note 1)	$I_{DM}$	-150	A
Single Pulsed Avalanche Energy(L=0.1mH)	$E_{AS}$	84	mJ
Maximum Power Dissipation	$P_D$	45	W
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 To 150	°C

### Thermal Characteristic

Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	2.8	°C/W
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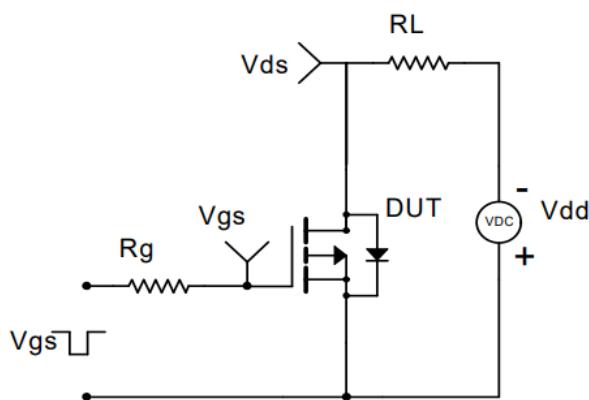
**Electrical Characteristics (TC=25°C unless otherwise noted)**

Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=-250\mu A$	-	-30	-	V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=-28V, V_{GS}=0V$	-	-	-1	$\mu A$
Gate-Body Leakage Current	$I_{GSS}$	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	$\pm 100$	nA
<b>On Characteristics (Note 3)</b>						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	-1.0	-1.5	-2.5	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=-10V, I_D=-20A$	-	8.8	11	$m\Omega$
		$V_{GS}=-4.5V, I_D=-10A$	-	14	17	$m\Omega$
Forward Transconductance	$g_{FS}$	$V_{DS}=-10V, I_D=-20A$	-	30	-	S
<b>Dynamic Characteristics (Note 4)</b>						
Input Capacitance	$C_{iss}$	$V_{DS}=-15V, V_{GS}=0V, F=1.0MHz$	-	1270	-	pF
Output Capacitance	$C_{oss}$		-	350	-	pF
Reverse Transfer Capacitance (Note 4)	$C_{rss}$		-	120	-	pF
Gate Resistance	$R_g$	$V_{DS}=0V, V_{GS}=0V, F=1.0MHz$	-	35	-	$\Omega$
<b>Switching Characteristics</b>						
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=-15V, I_D=-10A, R_L=1\Omega, V_{GS}=-10V, R_G=3\Omega$	-	9	-	nS
Turn-on Rise Time	$t_r$		-	7	-	nS
Turn-Off Delay Time	$t_{d(off)}$		-	24	-	nS
Turn-Off Fall Time	$t_f$		-	10	-	nS
Total Gate Charge	$Q_g$	$V_{DS}=-15V, I_D=-10A, V_{GS}=-10V$	-	24	-	nC
Gate-Source Charge	$Q_{gs}$		-	3.5	-	nC
Gate-Drain Charge	$Q_{gd}$		-	6	-	nC
<b>Drain-Source Diode Characteristics</b>						
Diode Forward Voltage (Note 3)	$V_{SD}$	$V_{GS}=0V, I_S=-1A$	-	-	-1.2	V
Diode Reverse Recovery Time	$t_{rr}$	$IF=-20A, dI/dt=100A/\mu s$	-	24	-	nS
Diode Reverse Recovery Charge	$Q_{rr}$		-	41	-	nC

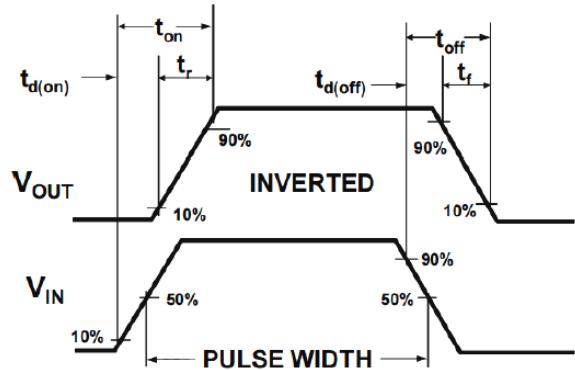
**Notes:**

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
3. Pulse Test: Pulse Width  $\leq 300\mu s$ , Duty Cycle  $\leq 2\%$ .
4. Guaranteed by design, not subject to product.

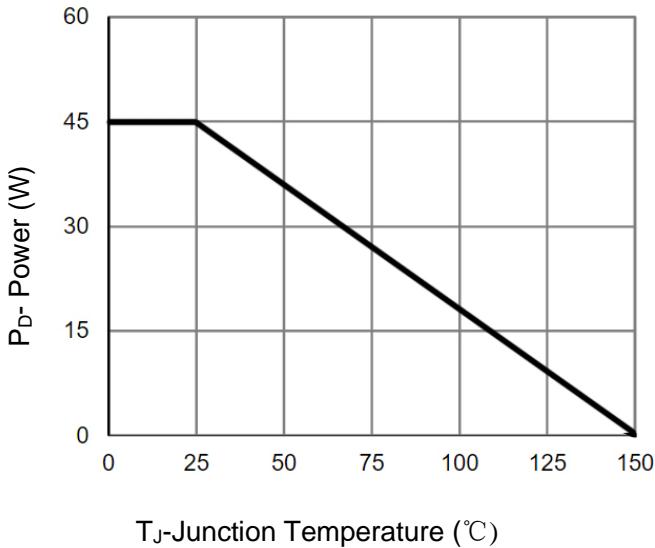
### Typical Electrical and Thermal Characteristics



**Figure 1** Switching Test Circuit

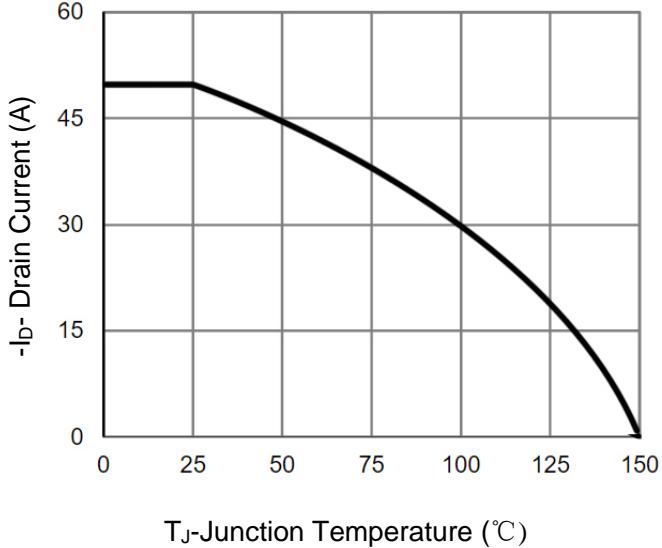


**Figure 2** Switching Waveform



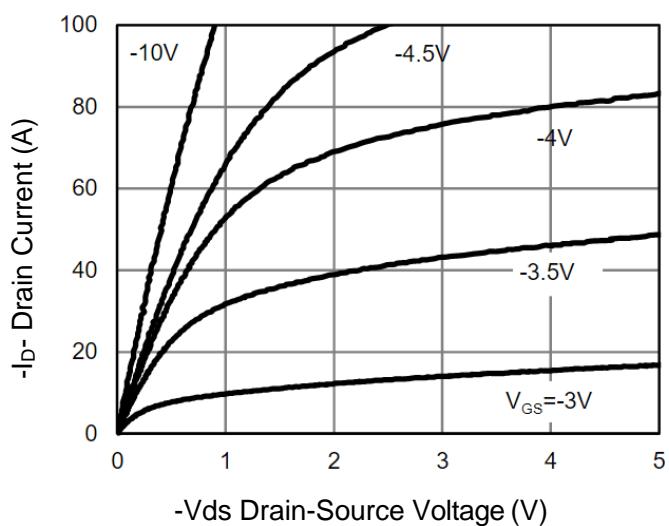
T<sub>J</sub>-Junction Temperature (°C)

**Figure 3** Power De-rating

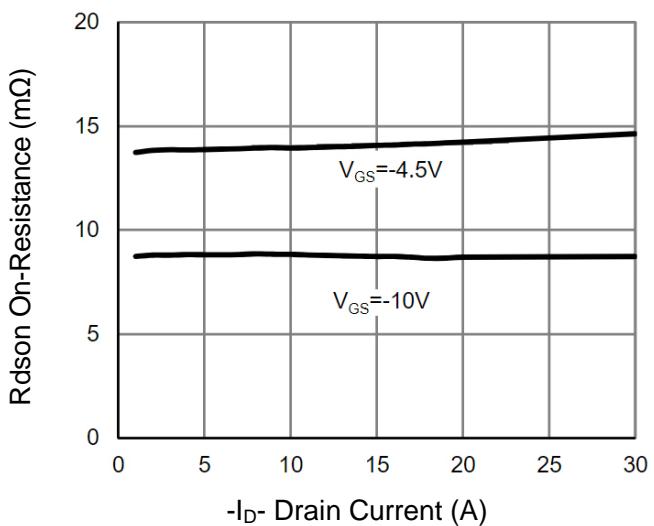


T<sub>J</sub>-Junction Temperature (°C)

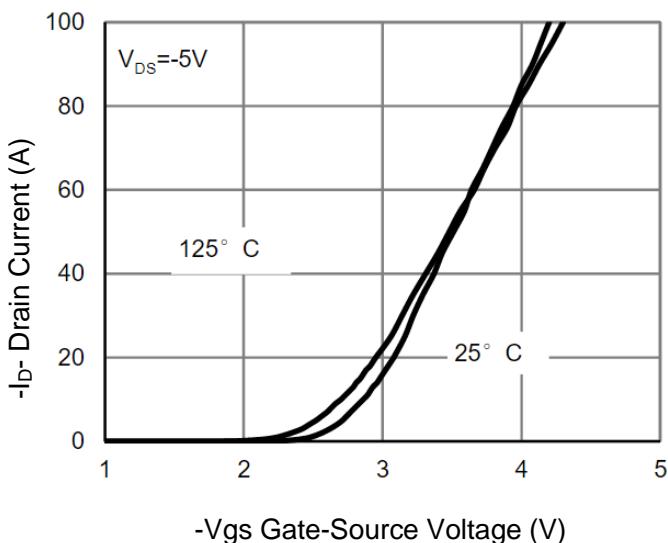
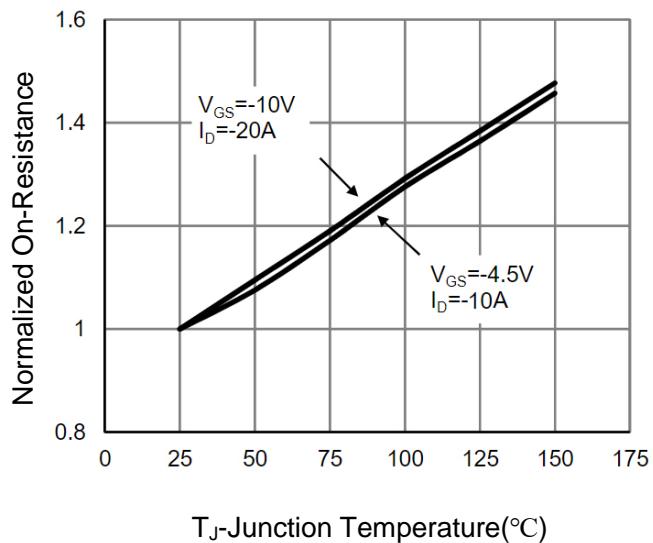
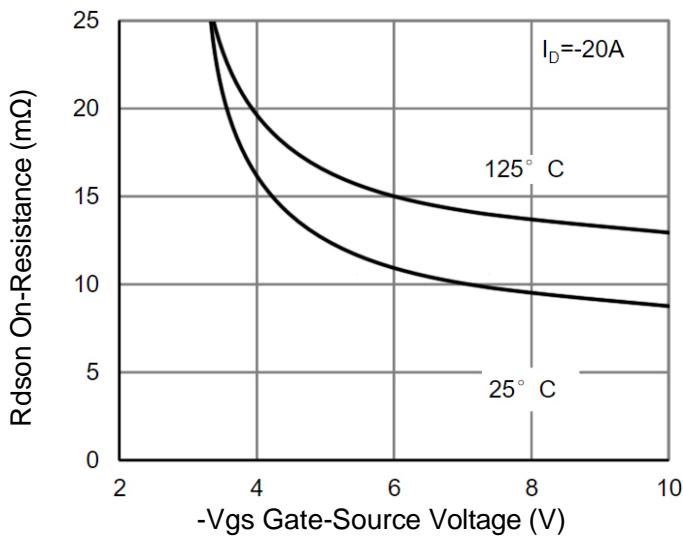
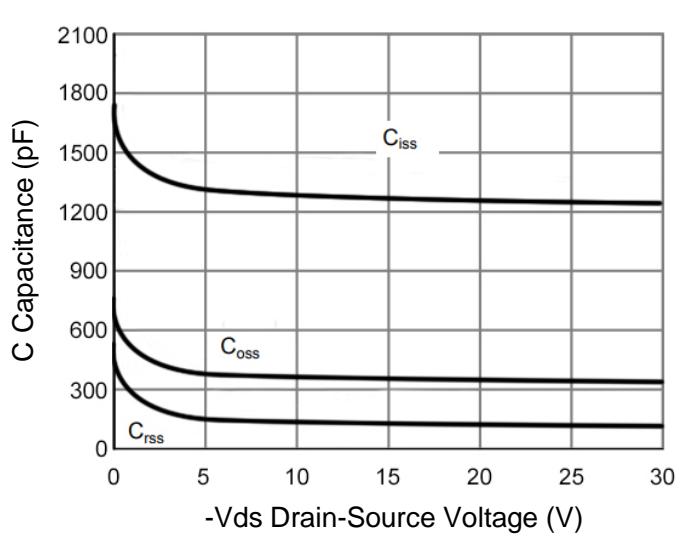
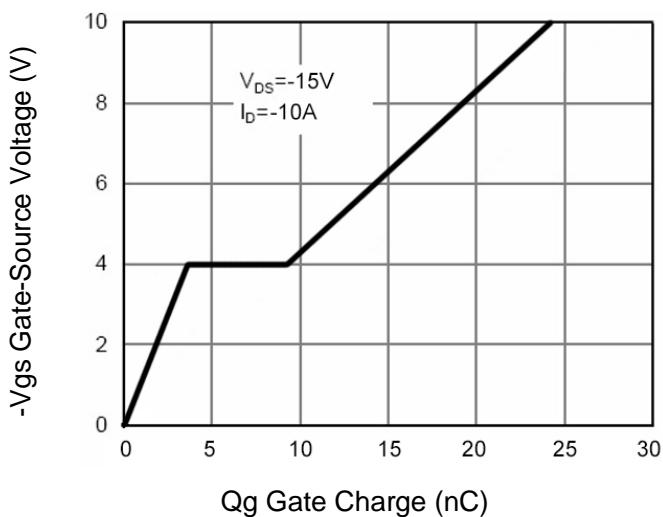
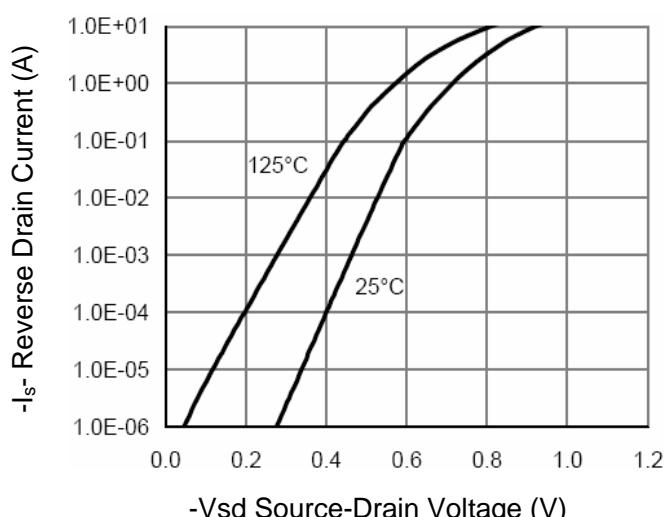
**Figure 4** Drain Current



**Figure 5** Output Characteristics



**Figure 6** Rdson vs Drain Current

**Figure 7 Transfer Characteristics****Figure 8 Rdson vs Junction Temperature****Figure 9 Rdson vs Vgs****Figure 10 Capacitance vs Vds****Figure 11 Gate Charge****Figure 12 Source- Drain Diode Forward**

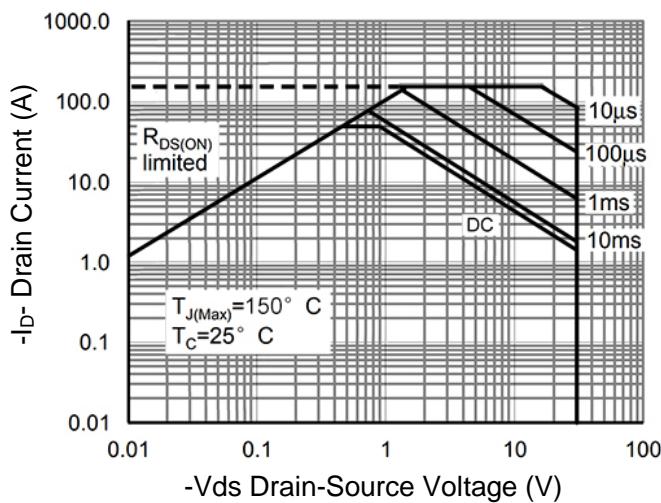


Figure 13 Safe Operation Area

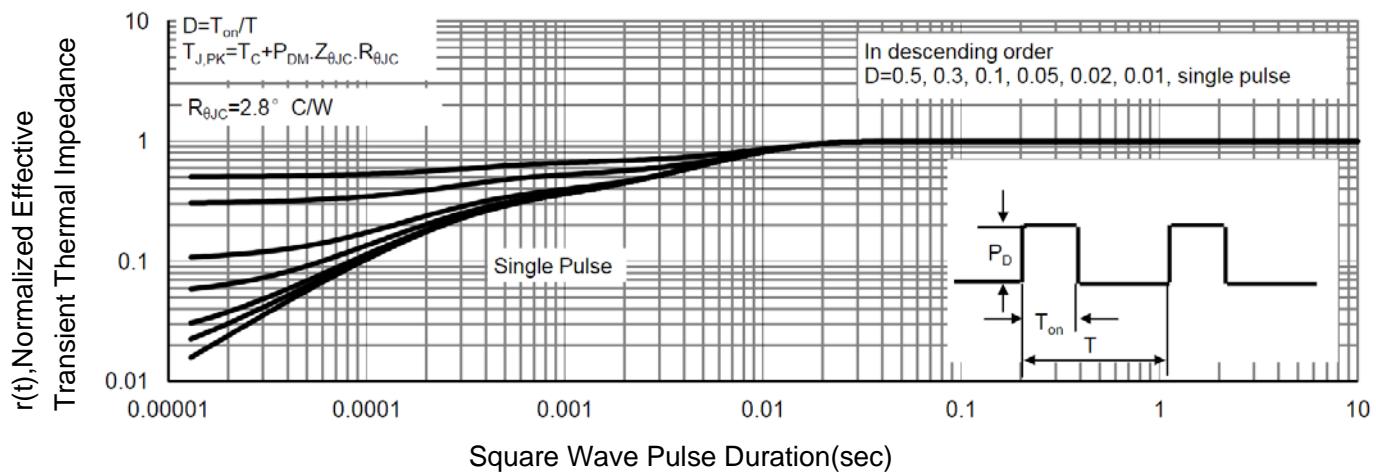
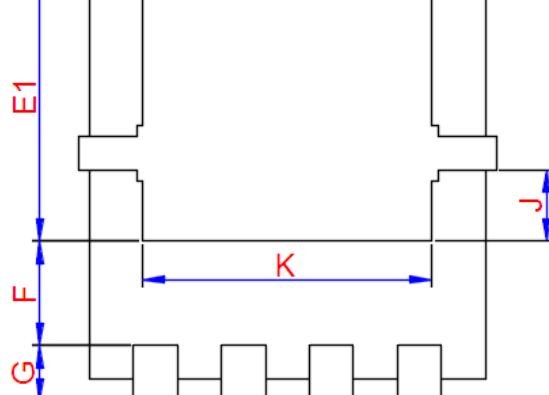
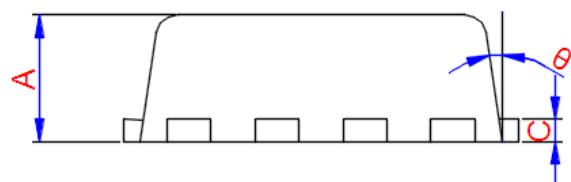
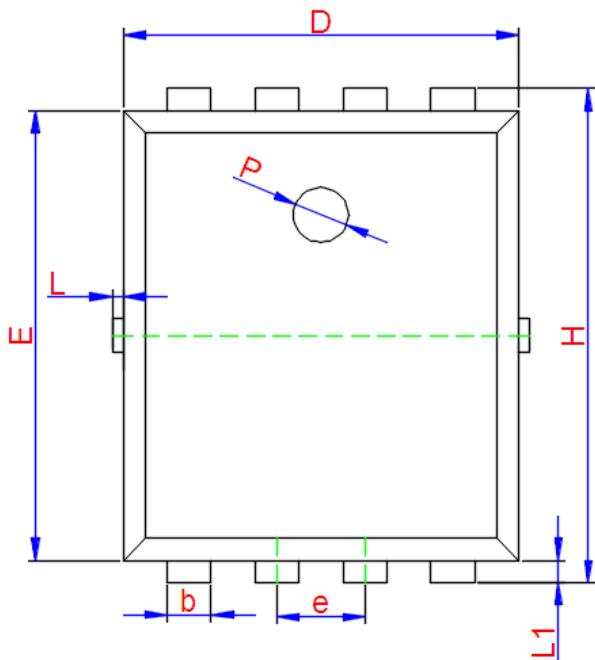


Figure 14 Normalized Maximum Transient Thermal Impedance

## DFN5x6-8L Package Information



Symbol	Dimensions In Millimeters		
	Min.	Typ.	Max.
A	0.800	1.050	1.200
b	0.250	0.350	0.490
c	0.254TYP.		
D	4.800	5.000	5.100
e	1.270TYP.		
E	5.650	5.800	5.900
E1	3.400TYP.		
F	1.300TYP.		
G	0.600TYP.		
H	5.950	6.080	6.200
J	0.950TYP.		
K	4.000TYP		
L	-	-	0.150
L1	0.100	0.140	0.180
P	1.180TYP.		
θ	6°	10°	14°